



TD3083 Zero Volt Switching 800V Triac Driver



Description

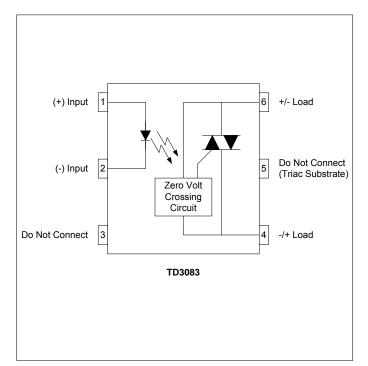
The TD3083 consists of a single input LED optically coupled to a zero-volt crossing triac driver. The TD3083 provides high input-to-output isolation and is designed to drive high-powered triacs. Typical uses include interfacing logic level control signals to equipment powered from $240V_{AC}$ lines and higher.

The TD3083 comes standard in a miniature 6 pin DIP package making it ideal for high-density board applications.

Applications

- Home Appliances
- Motor / Drive Controls
- Solid State Relays
- Solenoid / Valve Control
- Temperature Control

Schematic Diagram



Features

- Zero-Volt Switching
- 800V Blocking Voltage
- Trigger Current (5mA MAX)
- High Isolation Voltage (5000V_{RMS})
- High dV/dt (1kV/µS MIN, 2kV/µS TYP)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL/C-UL:	File # E201932
VDE:	File # 40035191 (EN 60747-5-2)

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature	55 to +125°C
Operating Temperature	
Continuous Input Current	50mA
Transient Input Current	400mA
Reverse Input Control Voltage	5V
Input Power Dissipation	40mW
Output Power Dissipation	330mW
Solder Temperature – Wave (10sec)	260°C
Solder Temperature – IR Reflow (10sec)	260°C

Ordering Information

Part Number	Description
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TD3083	6 pin DIP, (60/Tube)
TD3083-H	0.40" (10.16mm) Lead Spacing (VDE0884)
TD3083-S	6 pin SMD, (60/Tube)
TD3083-STR	6 pin SMD, Tape and Reel (1000/Reel)

NOTE: Suffixes listed above are not included in marking on device for part number identification



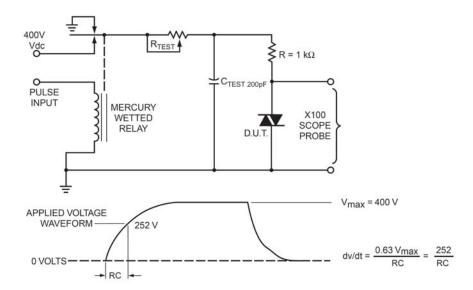
Electrical Characteristics, T_A = 25°C (unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions	
Input Specifications							
LED Forward Voltage	V _F	-	1.4	1.8	V	I _F = 10mA	
LED Reverse Voltage	BV _R	5	-	-	V	I _R = 10μΑ	
Reverse Leakage Current	I _{InRleak}	-	-	10	μA	V _R = 6µA	
Trigger Current ¹	I _{FT}	-	-	5	mA	Main Terminal Voltage = 3V	
Output Specifications							
Blocking Voltage	V _{DRM}	800	-	-	V	I ₀ = 1μA	
Peak Blocking Current	I _{DRM1}	-	60	500	nA	V _{DRM} = 800V	
On-State Voltage	V _{ON}	-	1.8	3	V	I _F = 5mA, I _{TM} = 100mA	
Leakage Current	I _{DRM2}	-	0.2	1	μA	I _F =0mA, V _{DRM} = 800V	
Holding Current	I _{HOLD}	-	100	-	μA	-	
Inhibit Voltage	V _{INH}	-	5	20	V	I _F = 5mA	
Critical Rate of Rise ²	dV/dt	1000	2000	-	V/µS	-	
Isolation Specifications							
Isolation Voltage	V _{ISO}	5,000	-	-	V _{RMS}	RH ≤ 50%, t=1min	
Input-Output Resistance	R _{I-O}	-	10 ¹²	-	Ω	V _{I-O} = 500V _{DC}	

Note 1: Resistive load. For inductive loads, higher drive current is recommended

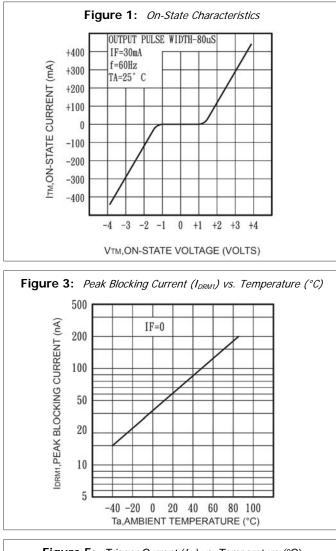
Note 2: This is for static dV/dt. Test Circuit Below

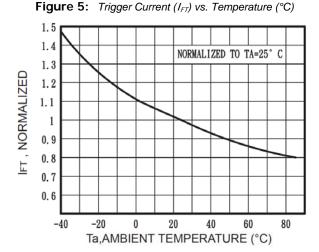
TD3083 Static dV/dt Test Circuit:

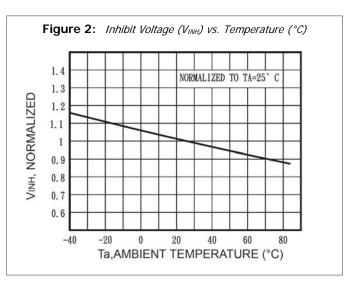


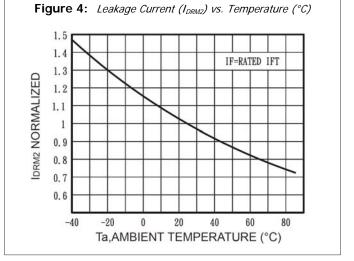


TD3083 Performance & Characteristics Plots, T_A = 25°C (unless otherwise specified)











TD3083 Solder Temperature Profile Recommendations

(1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:

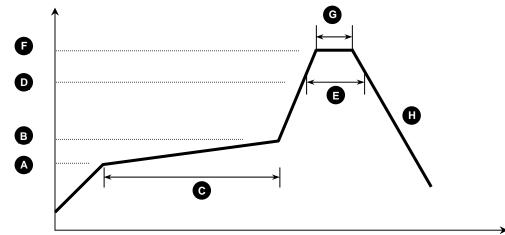


Figure 1

Process Step	Description	Parameter	
А	Preheat Start Temperature (°C)	150°C	
В	Preheat Finish Temperature (°C)	180°C	
С	Preheat Time (s)	90 - 120s	
D	Melting Temperature (°C)	230°C	
E	Time above Melting Temperature (s)	30s	
F	Peak Temperature, at Terminal (°C)	260°C	
G	Dwell Time at Peak Temperature (s)	10s	
H	Cool-down (°C/s)	<6°C/s	

(2) Wave Solder:

Maximum Temperature:	260°C (at terminal)
Maximum Time:	10s
Pre-heating:	100 - 150°C (30 - 90s)
Single Occurrence	

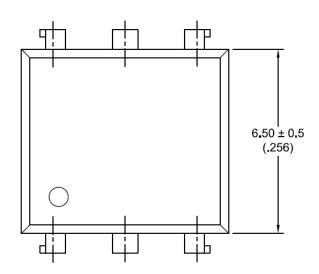
(3) Hand Solder:

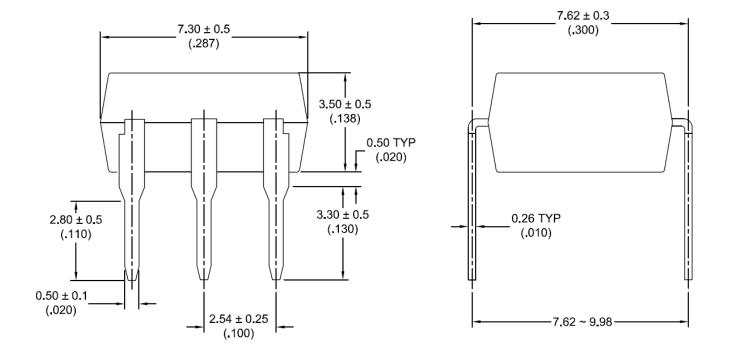
Maximum Temperature: Maximum Time:	350°C 3s	(at tip of soldering iron)
Single Occurrence		



6 PIN DIP Package

Note: All dimensions in millimeters with inches ["] in parenthesis ()

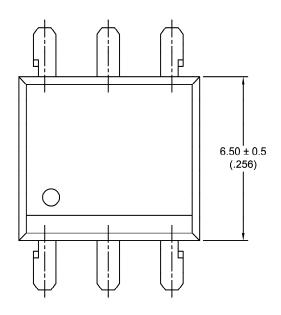


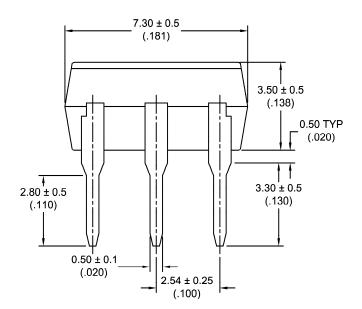


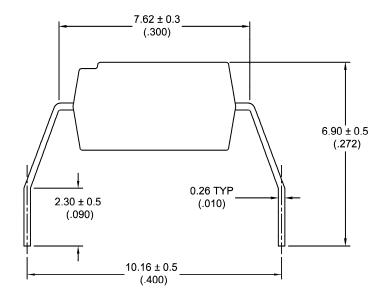


6 PIN WIDE Lead Space Package (-H)

Note: All dimensions in millimeters [mm] with inches in parenthesis ()



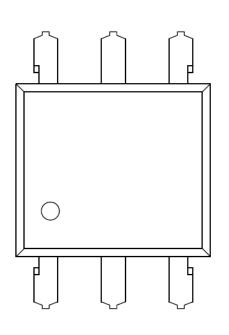


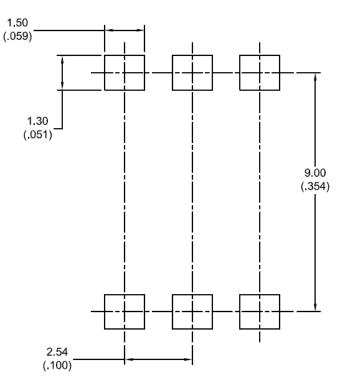


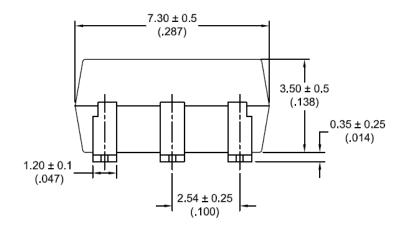


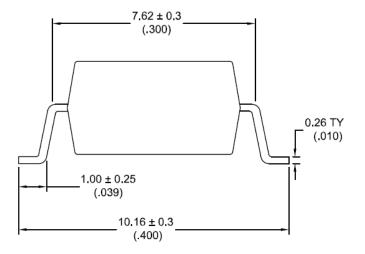
6 PIN SMD Surface Mount Package (-S)

Note: All dimensions in millimeters with inches ["] in parenthesis ()





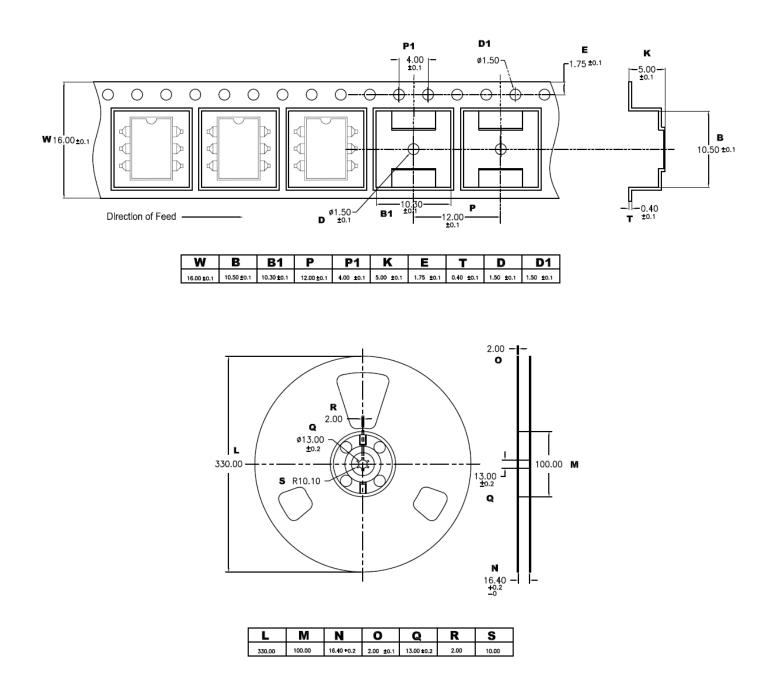






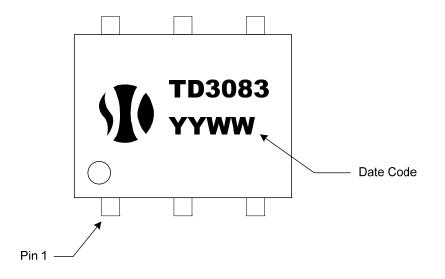
6 PIN SMD Tape & Reel (-STR)

Note: All dimensions in millimeters





TD3083 Package Marking



TD3083 Package Weights

Device	Single Unit	Full Tube (60pcs)	Full Pouch (10 tubes)	Full Reel (1000pcs)
TD3083	0.41	43	450	-
TD3083-S	0.40	42	440	-
TD3083-H	0.42	44	460	
TD3083-STR	0.40	-	-	880

Note: All weights above are in GRAMS, and include packaging materials where applicable

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